Silicon NPN Epitaxial

# **HITACHI**

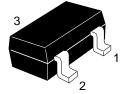
ADE-208-1080A (Z) 2nd. Edition Mar. 2001

#### **Application**

UHF/VHF wide band amplifier

#### **Outline**

MPAK 2SC3127



- 1. Emitter
- 2. Base
- 3. Collector

Note: Marking for 2SC3127 is "ID-".



TO-92 (2) 2SC3128, 2SC3510



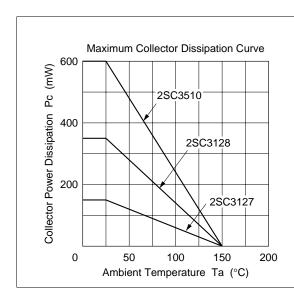
- 1. Base
- 2. Emitter
- 3. Collector

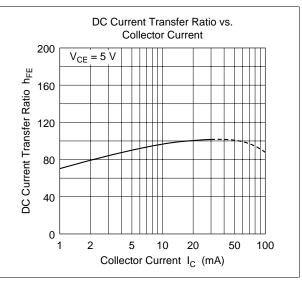
## **Absolute Maximum Ratings** ( $Ta = 25^{\circ}C$ )

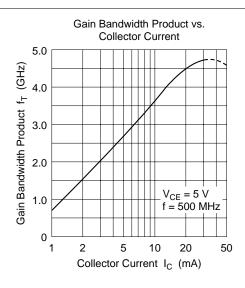
Item	Symbol	2SC3127*1	2SC3128	2SC3510	Unit
Collector to base voltage	$V_{\text{CBO}}$	20	20	20	V
Collector to emitter voltage	V <sub>CEO</sub>	12	12	12	V
Emitter to base voltage	$V_{EBO}$	3	3	3	V
Collector current	I <sub>c</sub>	50	50	50	mA
Collector power dissipation	P <sub>c</sub>	150	350	600	mW
Junction temperature	Tj	150	150	150	°C
Storage temperature	Tstg	-55 to +150	-55 to +150	-55 to +150	°C

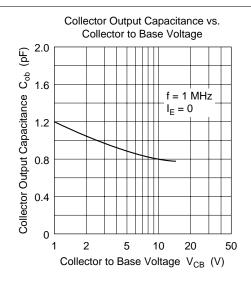
#### **Electrical Characteristics** ( $Ta = 25^{\circ}C$ )

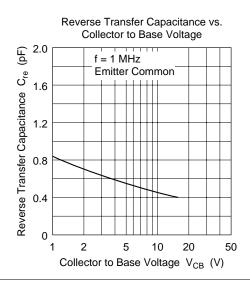
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	20	_	_	V	$I_{\rm C} = 10 \; \mu \text{A}, \; I_{\rm E} = 0$
Collector to emitter breakdown voltage	$V_{\text{(BR)CEO}}$	12	_	_	V	$I_{C} = 1 \text{ mA}, R_{BE} = \infty$
Emitter cutoff current	I <sub>EBO</sub>	_	_	10	μΑ	$V_{EB} = 3 \text{ V}, I_{C} = 0$
Collector cutoff current	I <sub>CBO</sub>	_	_	0.5	μΑ	$V_{CB} = 12 \text{ V}, I_{E} = 0$
DC current transfer ratio	$h_{FE}$	30	90	200		$V_{CE} = 5 \text{ V}, I_{C} = 20 \text{ mA}$
Collector output capacitance	Cob	_	0.9	1.5	pF	$V_{CB} = 5 \text{ V}, I_{E} = 0, f = 1 \text{ MHz}$
Gain bandwidth product	$f_{T}$	3.5	4.5	_	GHz	$V_{CE} = 5 \text{ V}, I_{C} = 20 \text{ mA}$
Power gain	PG	_	10.5	_	dB	$V_{CE} = 5 \text{ V}, I_{C} = 20 \text{ mA},$ f = 900 MHz
Noise figure	NF	_	2.2	_	dB	$V_{CE} = 5 \text{ V}, I_{C} = 5 \text{ mA},$ f = 900 MHz

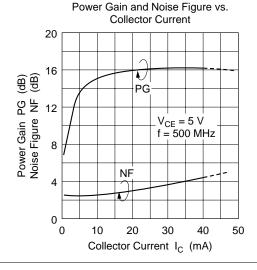


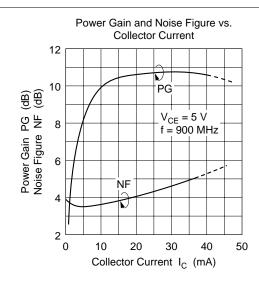


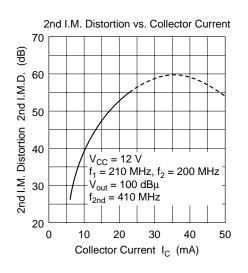


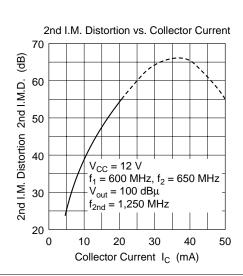


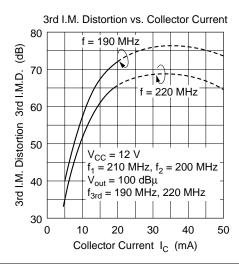


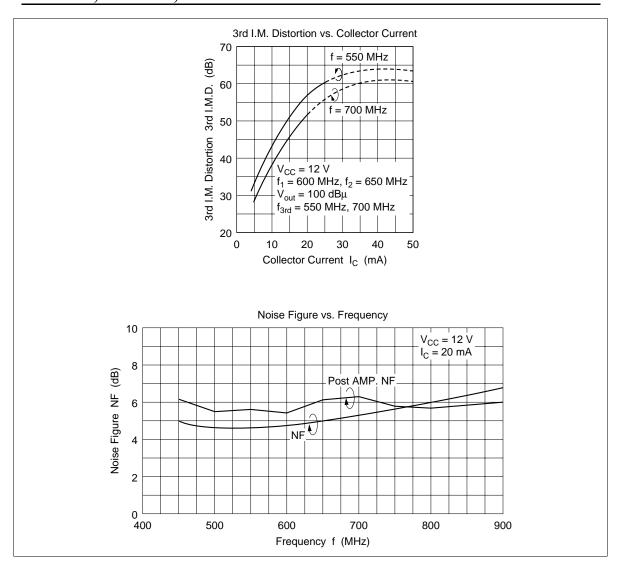


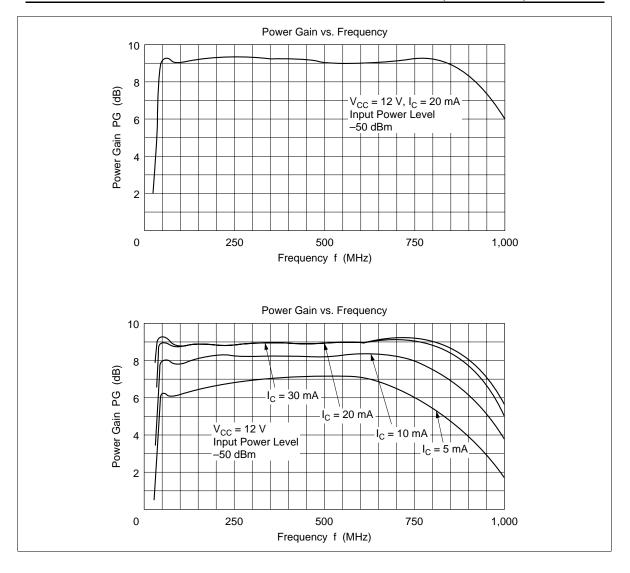


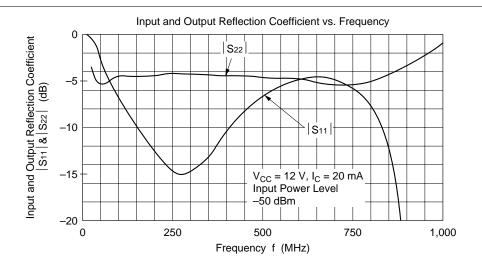




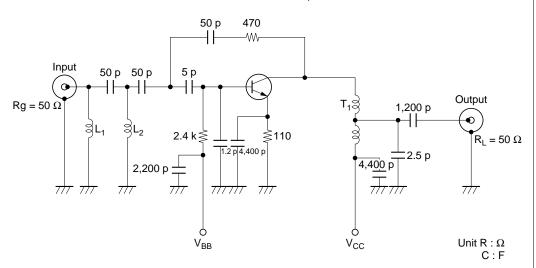








#### Vhf to Uhf Wide Band Amp. Circuit



#### Parts Speecification

 $L_1$ : Inside dia  $\phi 3.0$  mm,  $\phi 0.4$  mm Polyurethane Coated Copper wire 12 Turns.

 $L_2$ : Inside dia  $\phi 3.5$  mm,  $\phi 0.5$  mm Polyurethane Coated Copper wire 9 Turns.

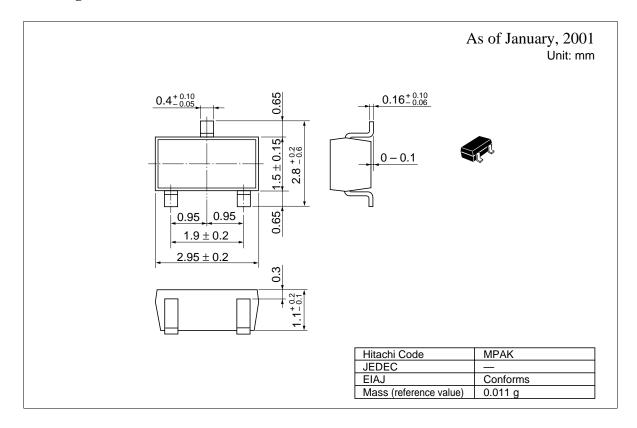
T<sub>1</sub>: Balance wind used Ferrite Core

Outside dia  $\phi 4.0$  mm, Inside dia  $\phi 2.0$  mm

 $\phi 0.1 \ mm$  Polyurethane Coated Copper wire 3 Turns.

Ratio Input to Output is 2:1

#### **Package Dimensions**



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